

Tokyo Seimitsu Co., Ltd. Earnings Conference for FY2024/3 2nd Quarter

November 2nd, 2023

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* This transcript is an English translation and summary of information provided verbally in Japanese.

◆ Cautionary Statement with respect to Forward-Looking Statements

- ◆ This presentation data and information verbally provided contain “forward-looking statements” that are based on current best available information and policies.
- ◆ There are various factors such as world economic conditions and semiconductor/automobile market conditions which will directly and indirectly impact the Company’s results in the future.
- ◆ As a result, future outcomes may differ from those projected in this presentation.

◆ Wordings and Data in presentation

- ◆ Unless otherwise noted, “**SPE**” denotes our Semiconductor Production Equipment Business Segment, “**Metrology (or Metr.)**” denotes our Metrology Business Segment, “**Net profit**” denotes Net profit attributable to owner of the parent, and “**MTP**” denotes “Mid-term Business Plan.”
- ◆ Information listed in this presentation is summarized in Billions of Yen (**BJPY or B**) or percentage except as otherwise noted. As a result, there may be a case where the total of individual amount and total amounts in each matter may differ.
- ◆ Effective from FY2023/3, income and expenses of foreign subsidiaries are converted to Japanese Yen using the average rate during the period, instead of the previous end-of-period rate. Accordingly, the figures for FY2022/3 are retroactively applied to the average rate for the period.

◆ Audit procedure

- ◆ This presentation is not subject to audit procedures.

Agenda

- ◆ **Business results for FY2024/3 2Q**
- ◆ Forecast for FY2024/3
- ◆ MTP Summary and Future Business Opportunities
- ◆ Q&A

FY2024/3 2Q and 1H Business Results



Half Year Results (BJPY)	FY2023/3		FY2024/3			
	1H	2H	1H	Vs. Fcst	HoH	YoY
Orders	80.2	56.1	59.5		+6%	-26%
Sales	71.1	75.7	63.5	+2.5	-16%	-11%
Operating Profit (OP Margin)	15.7 (22%)	18.8 (25%)	11.4 (18%)	+0.4	-39%	-27%
Recurring Profit	16.6	18.7	12.1	+1.1	-36%	-27%
Net Profit	11.9	11.7	8.5	+0.5	-27%	-28%

Quarter (BJPY)	1Q	2Q	3Q	4Q	1Q	2Q	QoQ	YoY
Orders	46.2	34.0	30.1	26.0	29.5	29.9	+1%	-12%
Sales	27.9	43.2	32.0	43.7	26.6	36.9	+39%	-14%
Operating Profit (OP Margin)	5.7 (20%)	10.0 (23%)	7.4 (23%)	11.4 (26%)	4.3 (16%)	7.1 (19%)	+68%	-29%
Recurring Profit	6.5	10.1	7.1	11.6	4.7	7.4	+56%	-27%
Net Profit	4.8	7.1	3.3	8.4	3.2	5.3	+63%	-25%

- Sales exceeded the forecast, mainly in consumable-related demand (in SPE)
- Orders increased HoH while decreased YoY

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- ◆ Hello everyone, I am Kimura, President and COO of Tokyo Seimitsu. Thank you very much for your continued support.
- ◆ I will now begin to explain our business performance for FY2024/3 1st half (1H) and 2nd Quarter (2Q) . FY2024/3 First half (1H), both sales and profits declined YoY due to a slowdown in the consumer electronic products, but slightly exceeded forecasts.
- ◆ 2Q results are shown in the bottom row. Both sales and profit increased QoQ.
- ◆ Next, I will explain by segment.

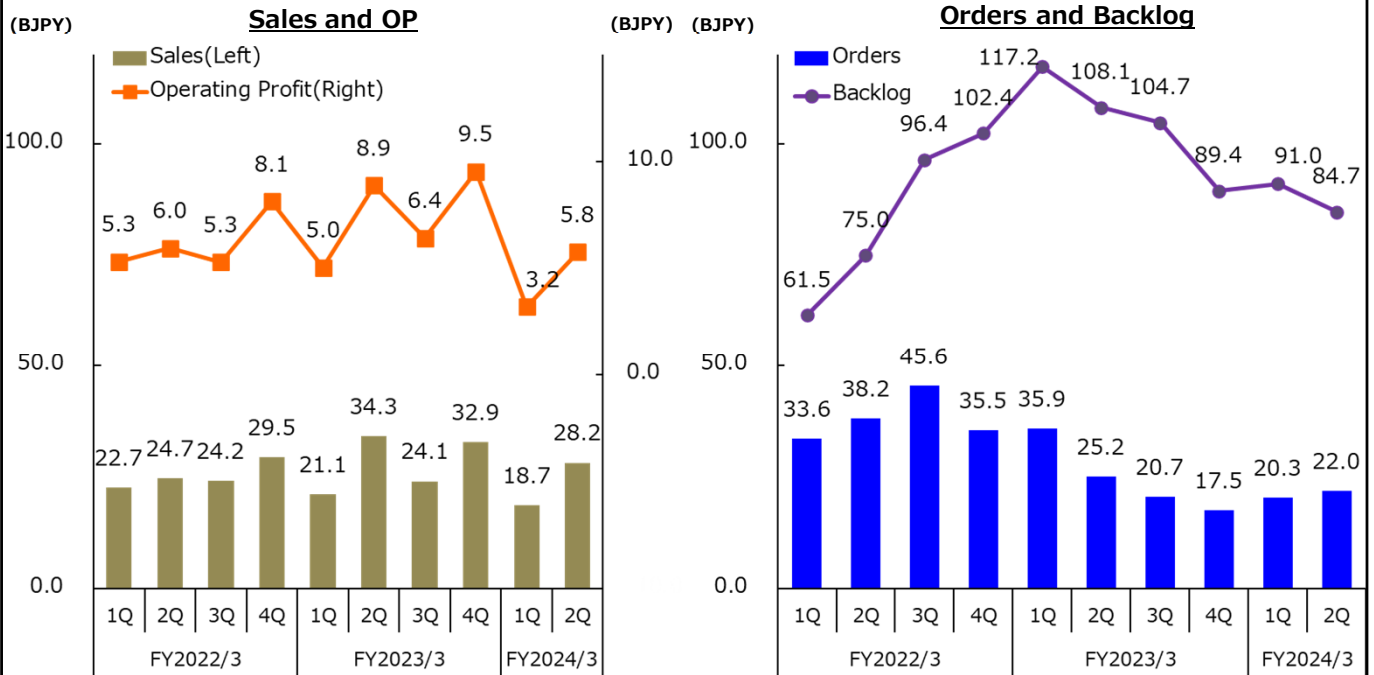
Segment Results (Half Year, BJPY)	FY2023/3		FY2024/3			
	1H	2H	1H	Vs. Fcst	HoH	YoY
Orders	61.2	38.2	42.3		+11%	-31%
Sales	55.4	57.0	47.0	+3.0	-18%	-15%
Operating Profit (OP Margin)	13.9 (25%)	15.9 (28%)	9.0 (19%)		-44%	-36%

Quarter (BJPY)	1Q	2Q	3Q	4Q	1Q	2Q	QoQ	YoY
Orders	35.9	25.2	20.7	17.5	20.3	22.0	+8%	-13%
Sales	21.1	34.3	24.1	32.9	18.7	28.2	+51%	-18%
Operating Profit (OP Margin)	5.0 (24%)	8.9 (26%)	6.4 (27%)	9.5 (29%)	3.2 (17%)	5.8 (20%)	+80%	-35%

- Orders increased YoY despite sluggish consumer-related demand
- 2Q OP margin recovered to the 20% level

- ◆ First, I would like to discuss the results of the SPE segment.
- ◆ 1H Orders, amid sluggish demand in the consumer-related market, increased HoH due to factors that will be explained later.
- ◆ 1H Sales exceeded the forecast due to the continued high level of production and shipments.
- ◆ Quarterly results are shown in the lower row.
2Q OP Margin recovered to the 20% level.

SPE – Quarterly Trend



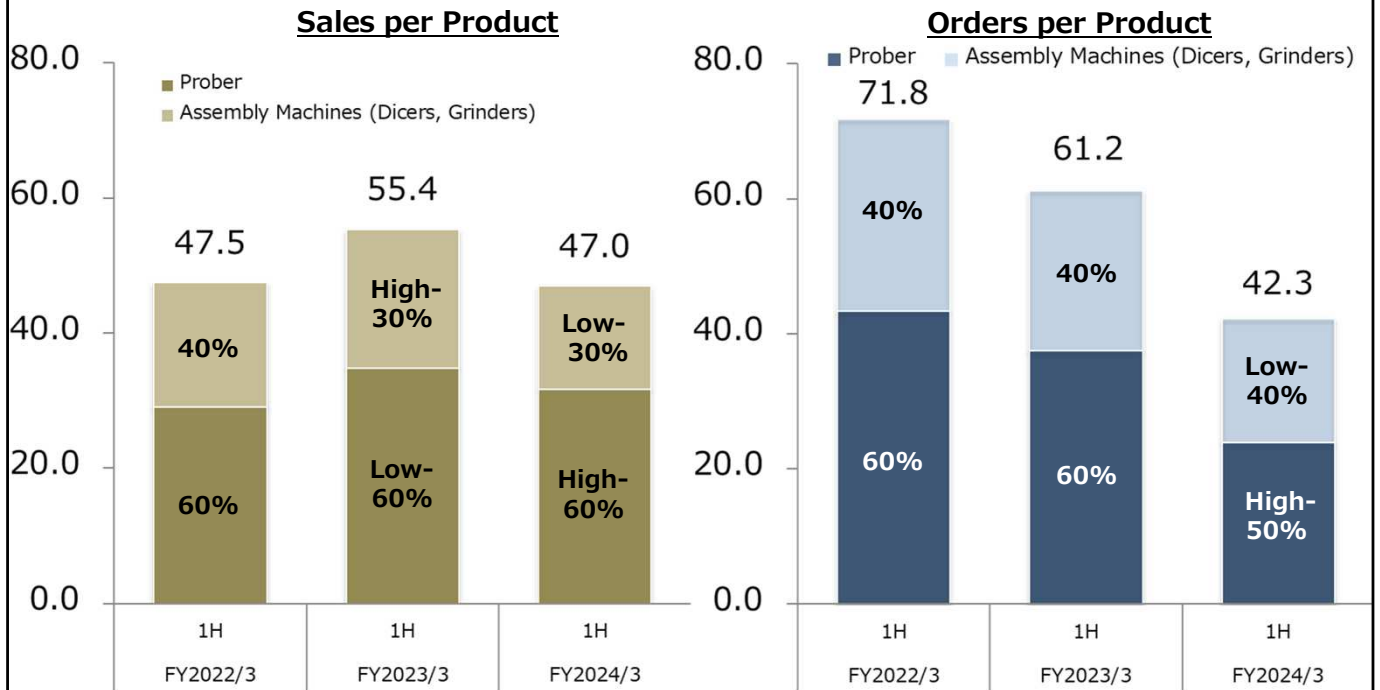
- Sales: Generally maintained high level of production and shipments
- Orders · Backlog: SiC power devices and generative AI underpinned booking in contract of week consumer-related market

◆ Here are the quarterly graph of SPE.

◆ 2Q sales in the graph on the left, which were in line with the company estimate (1Q < 2Q), as the adjustment of production slots proceeded without delay.

◆ On the right side, orders increased QoQ, supported by SiC power semiconductor and generated AI projects, despite soft consumer demand.

SPE – per Product



- Sales : No change in composition
- Orders : Assembly Machines demand relatively stable

- ◆ This chart shows sales and orders for SPE by product.
- ◆ The orders shown on the on the right graph, demands for Grinder kept firm tone amid weak consumable market, and the ratio of orders for assembly machines were relatively stable.

Metrology Segment



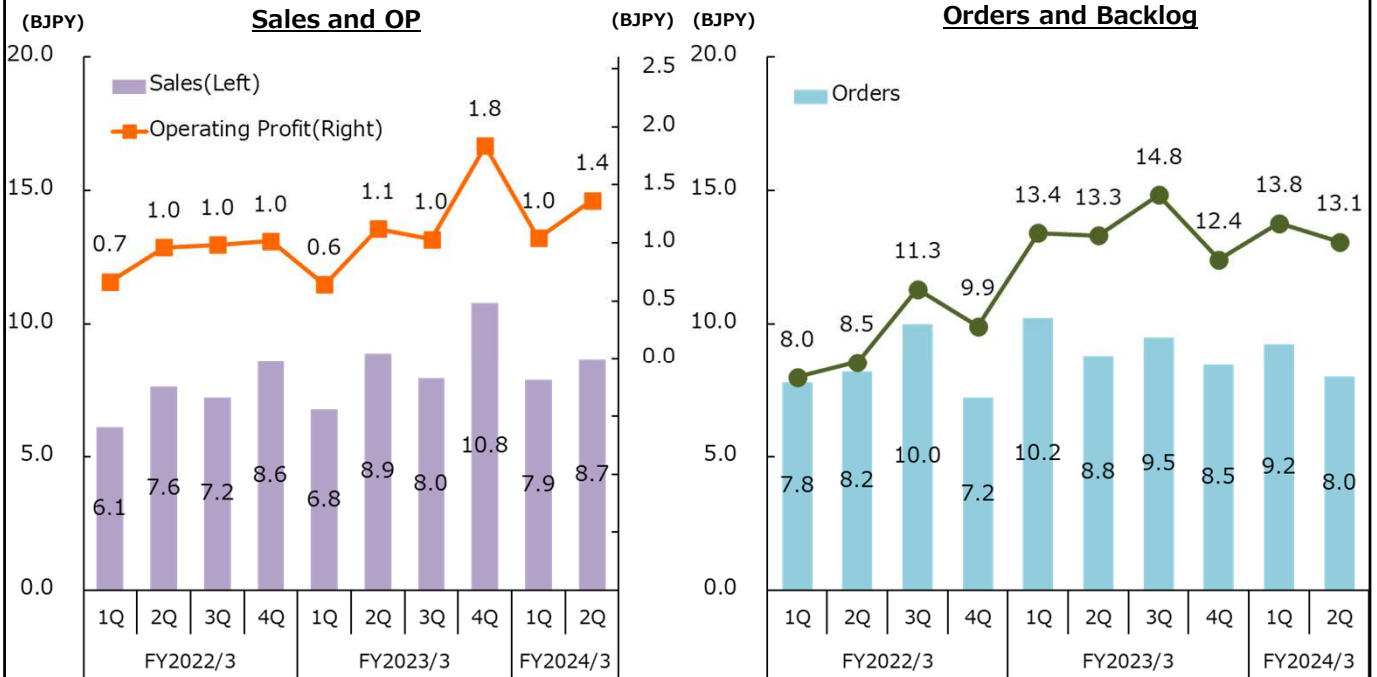
Segment Results (Half Year, BJPY)	FY2023/3		FY2024/3			
	1H	2H	1H	Vs. Fcst	HoH	YoY
Orders	19.0	17.9	17.2		-4%	-10%
Sales	15.7	18.8	16.6	-0.4	-12%	+6%
Operating Profit (OP Margin)	1.8 (11%)	2.9 (15%)	2.4 (15%)		-16%	+37%

Quarter (BJPY)	1Q	2Q	3Q	4Q	1Q	2Q	QoQ	YoY
Orders	10.2	8.8	9.5	8.5	9.2	8.0	-13%	-9%
Sales	6.8	8.9	8.0	10.8	7.9	8.7	+10%	-2%
Operating Profit (OP Margin)	0.6 (10%)	1.1 (13%)	1.0 (13%)	1.8 (17%)	1.0 (13%)	1.4 (16%)	+31%	+22%

- Sales were generally in line with expectations
- Orders declined mainly due to macroeconomic uncertainty.

- ◆ Next, I would like to discuss the results of the Metrology segment.
- ◆ Sales were generally in line with the forecasts.
- ◆ On the other hand, orders decreased YoY due to a growing tendency to postpone capital investment in key manufacturing industries, reflecting macroeconomic uncertainty.
- ◆ 2Q results were as set out on lower row.

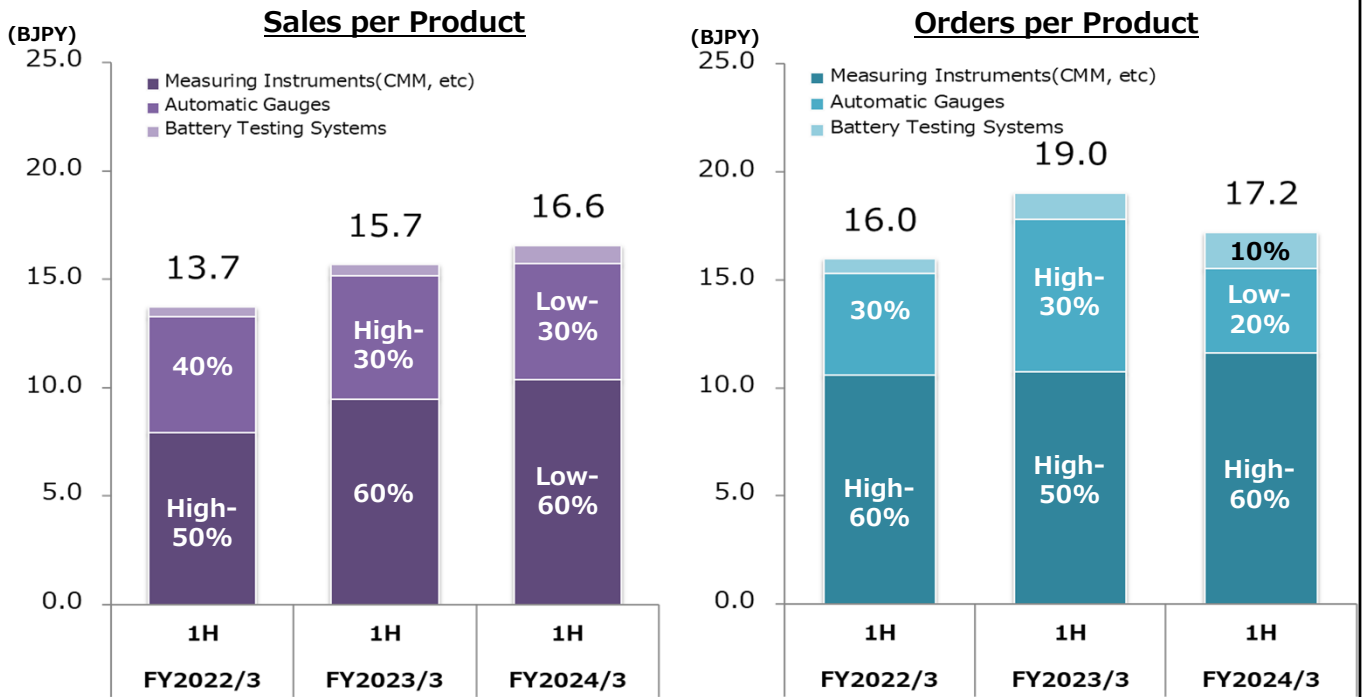
Metrology – Quarterly Trend



- Sales · OP : Sales were generally in line with expectations
- Orders: Despite macroeconomic uncertainty, EV-related orders increased

- ◆ Here are the quarterly graph of Metrology.
- ◆ On the left, 2Q sales and shipments were generally in line with our expectations.
- ◆ On the right side, orders increased in EV-related business despite softness in the manufacturing industry in general.

Metrology – per Product



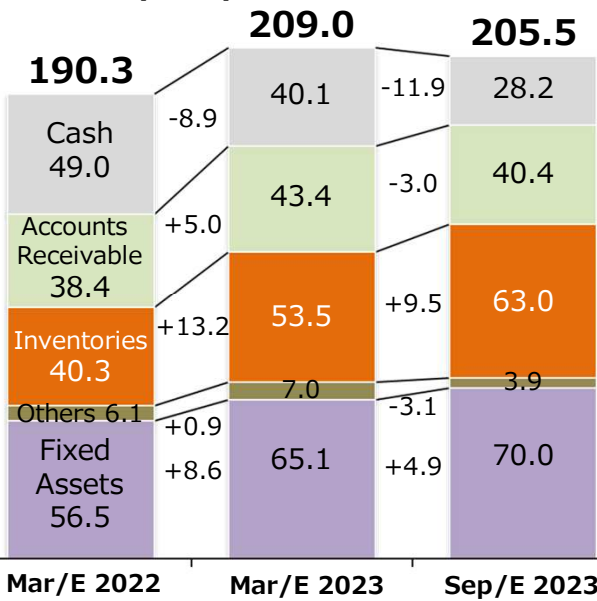
- Sales : No change in composition
- Orders : Orders for Charge/Discharge testing systems and Measuring instrument for EVs increased amid an overall adjustment trend

- ◆ This chart shows sales and orders for Metrology by product.
- ◆ On the right side, orders showed a general trend of adjustment. In particular, orders for Automatic Gauges declined, while orders for charge-discharge testing systems and measuring instruments for EV-related components increased.

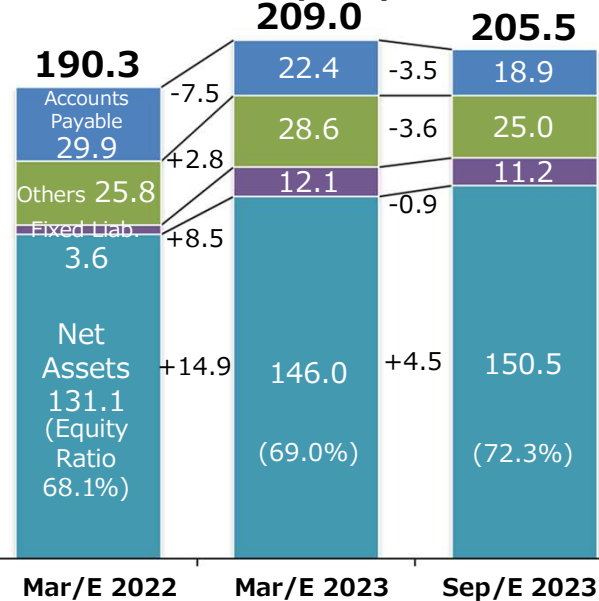
Balance Sheet



Assets (BJPY)



Liabilities / Net Assets (BJPY)

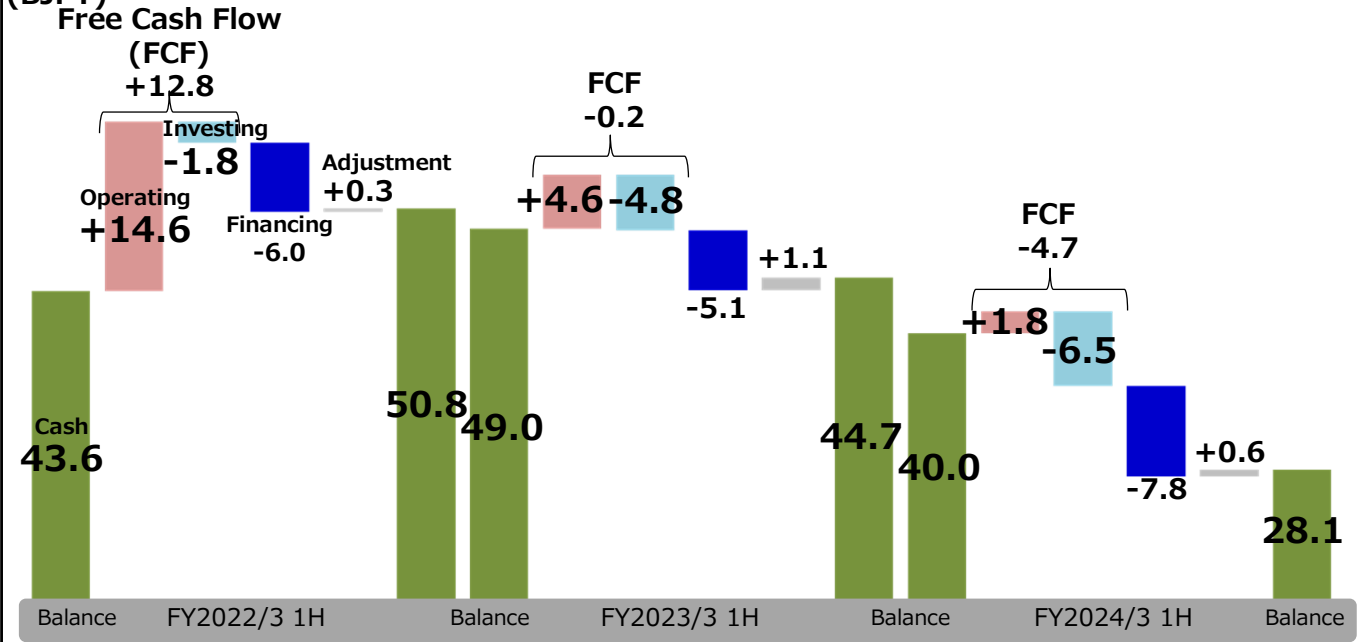


- Assets: Inventory increased in anticipation for future shipments
- Liabilities and Net Assets: Decrease in accounts payable (site shortening)

- ◆ Here is an explanation of the balance sheet.
- ◆ Total assets at the end of September 2023 were ¥205.5B.
- ◆ On the assets section on the left, inventories increased compared to the end of March 2023. This was partly due to an increase in inventories for future shipments.
- ◆ On the right side, as for liabilities, accounts payable decreased due to the shortening of the accounts payable site.
- ◆ The equity ratio at the end of September was 72.3%.

Cash Flows(CF)

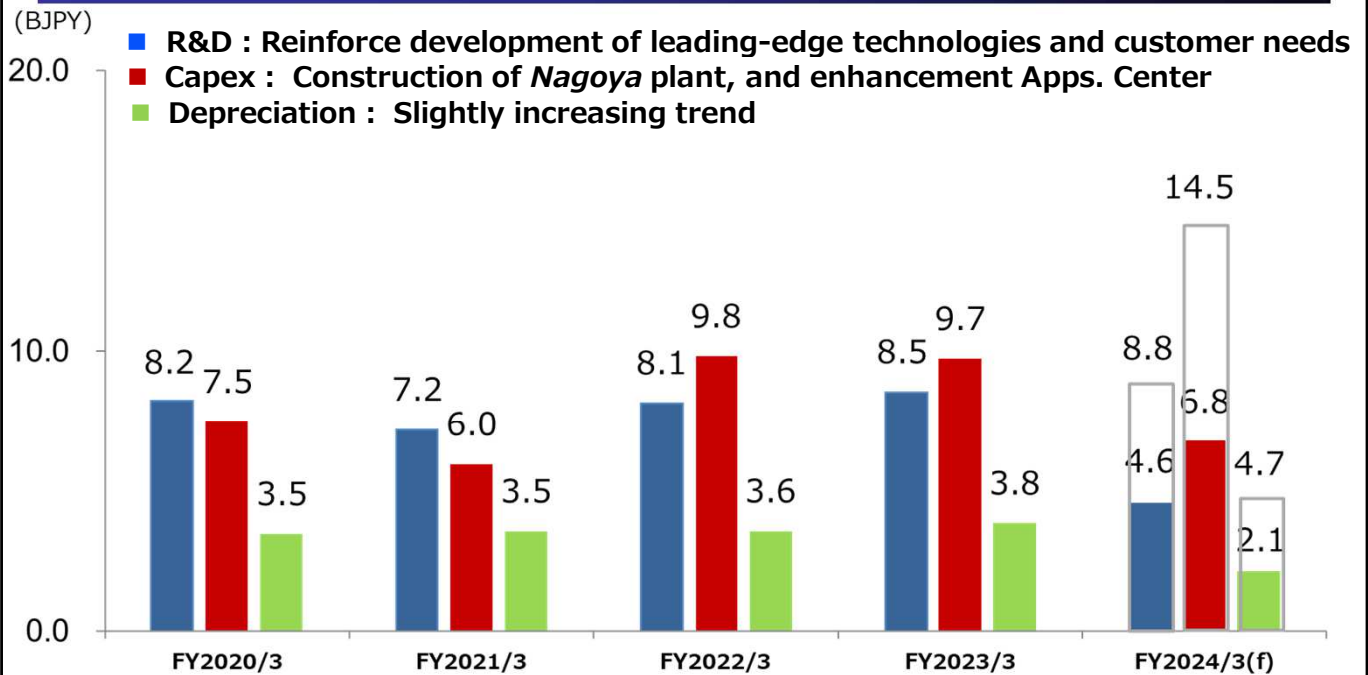
(BJPY)



➤ Negative FCF was mainly due to an increasing inventory and capex

- ◆ This is a summary of cash flows. These are 1H results for these 3 Fiscal Years.
- ◆ Free cash flow was -¥4.7B, resulting in a cash and cash equivalents balance of ¥28.1B at the end of 1H.
- ◆ This is mainly due to continued capital investment in anticipation of future growth, and an increase in inventories for the two consecutive periods in the light of high level of outstanding backlog.

R&D, Capex and Depreciation (results/plan)



➤ No change in R&D and other plans for FY2024/3

- ◆ Here are the results of R&D and capital expenditure, and the full-year plan for FY2024/3.
- ◆ R&D: FY2024/3 1H result was ¥4.6B, and we are in a lap. We will continue to strengthen development.
- ◆ Capex: FY2024/3 1H result was mainly for new SPE plants and application centers, amounted to ¥6.8B.
- ◆ Depreciation FY2024/3 1H result was ¥2.1B, and it is expected to gradual increase going forward.
- ◆ Here is a description of the FY2024/3 1H results so far.

Agenda

- ◆ Business results for FY2024/3 2Q
- ◆ **Forecast for FY2024/3**
- ◆ MTP Summary and Future Business Opportunities
- ◆ Q&A

- ◆ I will now explain our forecast for FY2024/3 Full Year.

Premises of FY2024/3 Forecasts

(Blue : changed by November)



Overall

- Continue to make necessary R&D and capital investments in anticipation of future growth

SPE

- 1H orders were sluggish against the backdrop of demand for consumer products, but recovered moderately in the 2H
- Solid sectors (AI, HBM, Hybrid Bonding, SiC, CIS, and China demand) will drive short- and medium-term demand

Metrology

- Customer's investment decisions are postponing
- Moderate recovery of ICE/rapid expansion of NEV for automotive
- Expand sales in non-automotive and strengthen solutions for automation

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- ◆ Here is an update of the Premises of FY2024/3 Forecasts announced in August, 2023, with the changes in blue.
- ◆ Overall, although the market as a whole is perceived as stagnant, we believe that significant growth can be realized in the next cycle, and we intend to proceed with R&D and capital investment necessary for growth as planned.
- ◆ As for the SPE segment, the consumer-related market continues to adjust and is expected to remain soft for the entire period of FY2024/3. On the other hand, we expect that firm fields such as SiC, AI, and China demand will support orders, and the high level of outstanding backlogs will drive sales.
- ◆ In Metrology segment, there is a trend toward postponing capital investment in various manufacturing industries. On the other hand, we will promote sales expansion in the NEV and non-automotive fields where growth is expected.

FY2024/3 Forecast



Full Year Results And Forecast(BJPY)	FY2023/3			FY2024/3				
	1H	2H	FY	1H	2H(f)	FY(f)	Vs. PrevFcst	YoY
Sales	71.1	75.5	146.8	63.5	68.5	132.0	+3.0	-10%
Operating Profit (OP Margin)	15.7 (22%)	18.8 (25%)	34.5 (24%)	11.4 (18%)	13.1 (19%)	24.5 (19%)	+0.5	-29%
Recurring Profit	16.6	18.7	35.3	12.1	13.3	25.4	+1.4	-28%
Net Profit	11.9	11.7	23.6	8.5	9.3	17.8	+0.8	-25%
Dividend per Share	235Yen			178Yen +8Yen -57Yen				

Per Segment

(SPE)	Orders	61.2	38.2	99.4	42.3				
	Sales	55.4	57.0	112.4	47.0	51.5	98.5	+4.5	-12%
(Metr.)	Orders	19.0	17.9	37.0	17.2				
	Sales	15.7	18.8	34.4	16.6	16.9	33.5	-1.5	-3%

- Revised full-year forecasts announced on May 12th, 2023
- Compared to the previous forecasts, increase in SPE sales despite decrease in Metrology Sales
- Forex assumption revised from ¥130 to ¥140 (Impact of yen appreciation of ¥1 per US dollar : ¥-120M)

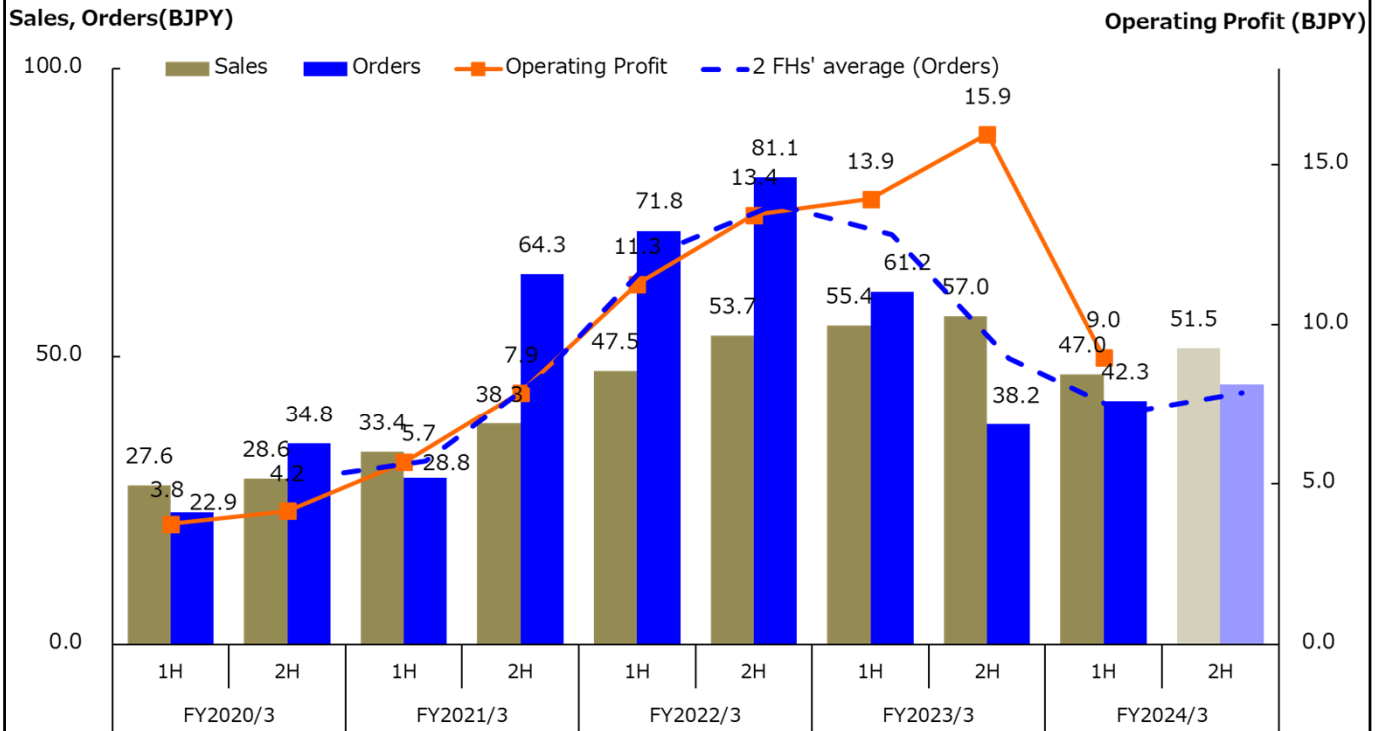
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- ◆ Based on the explanations given so far, we have revised our FY2024/3 Full Year forecast.
- ◆ In detail, SPE sales forecast was raised by ¥4.5B from the previous one given demand for power semis such as SiC and demand related to Generative AI, while in Metrology, sales forecast was lowered by ¥1.5B in light of the postponement trend in customers' capital investment.
- ◆ Based on these revisions, forecast for Operating profit was raised by ¥0.5B, Recurring profit by ¥1.4B, and Net profit by ¥0.8B, respectively.
- ◆ The annual per-share dividend projection has also been raised by ¥8 to ¥178.
- ◆ The exchange rate assumption has also been changed from ¥130 to the US dollar to ¥140.

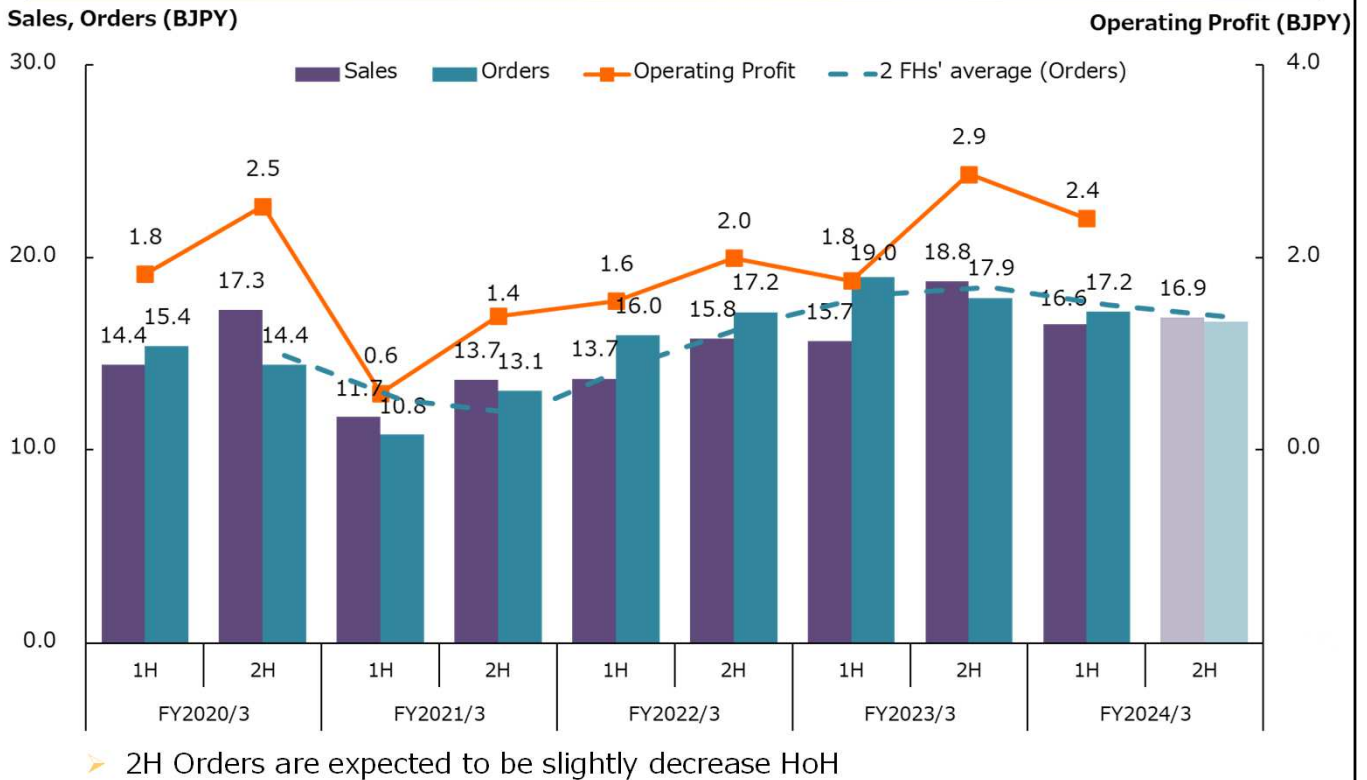
SPE – Sales/Orders incl. Forecasts



➤ 2H Orders are expected to be slightly increase HoH

- ◆ This page shows forecasts of SPE's sales and orders per Fiscal Half.
- ◆ This 2H orders are expected to be slightly higher HoH. Although there is continued weakness in consumer projects, orders in other solid areas likely to underpin entire booking amount.
- ◆ Outlook of product composition ratio both in sales and orders for FY2024/3 2H is; 60% for Probers, and 40% for Assembly machines.

Metrology – Sales/Orders incl. Forecasts



- ◆ This page shows forecasts of Metrology sales and orders per Fiscal Half.
- ◆ Orders in the 2H of this Fiscal year are expected to remain somewhat stagnant, as in the 1H.
- ◆ Outlook of product composition ratio for FY2024/3 2H is ; (1) in orders, 70% for Measuring Instruments, Low-20% for Automatic Gauges, and Low-10% for Battery Testing systems. (2) in sales, 60% for Measuring Instruments, and 30% for Automatic Gauges, and 10% for Battery Testing systems.

Agenda

- ◆ Business results for FY2024/3 2Q
- ◆ Forecast for FY2024/3
- ◆ **MTP Summary and Future Business Opportunities**
- ◆ Q&A

- ◆ Next, I will explain about our medium-term business plan (MTP), which concludes in FY2025/3, and future business opportunities.

➤ Quantitative target for FY2025/3

ROE	15% or more
Sales	¥170.0B (SPE ¥132.0B/Metrology ¥38.0B)
OP	¥37.5B (OP Margin : 22%)

➤ Company-wide actions

R&D

Reinforce development of leading-edge technologies and customer needs

Expand MFG capacity

Hanno Plant (FY2024/3) will realize ¥140B+ annual SPE capacity
Additional plant to be considered

Environment

Decrease CO2 emissions by 50% at CY2030 from FY2019/3
Investment also to be considered

KPIs for investment

Consider adopting ROIC for assessment to investment opportunities

Application enhancement

Strengthen demonstration capacity world-wide

Sustainability

Strengthen ESG initiatives

- ◆ Here are the quantitative targets of the medium-term business plan.
- ◆ We have set ROE of 15% or more, sales of ¥170.0B, and operating profit of ¥37.5B. The initiatives of the entire company are summarized in the lower part of this page.

- **Although the assumptions of MTP included possibility of an unturn in consumer electronics in FY2024/3, the trend is more sluggish than originally anticipated.**
- **On the other hand, new growth opportunities are recognized and could be a driving force in FY2025/3 and beyond.**
- **Therefore, we believe the probability of achieving the MTP remains high ; we will continue to make necessary investments.**



- ◆ The premise of this medium-term business plan is also based on the assumption of demand cycle movements for consumer electronics, and the initial scenario was including its recovery within FY2024/3. However, recovery has been delayed.
- ◆ On the other hand, the current demand for Generative AI, etc., was not factored in when the MTP was formulated, and is expected to expand rapidly over the next couple of years.
- ◆ By capturing this demand, we believe that we will be able to achieve the quantitative MTP target in FY2025/3, the final year of the MTP.
- ◆ Therefore, at this time, we will continue to commit to the investments necessary to achieve this goal.

Growth in grinder with Hybrid bonding

Prober's high-precision temperature control
→ expansion of added value

SiC processing market to shift from substrate to device

Synergies from the fusion of SPE and Metrology
→ Over ¥13.0B in 2025

Dramatic unit growth of NEV batteries

Increase in AI-related demand

Additional demand arisen from geopolitical changes

- ◆ We disclosed this page, a summary of our future growth opportunities, in this May. We added two (2) more opportunities to this page.
- ◆ We have added two new items to this page. Specifically, AI-related demand and demand due to geopolitical changes.
- ◆ I will explain in more detail on the next page.

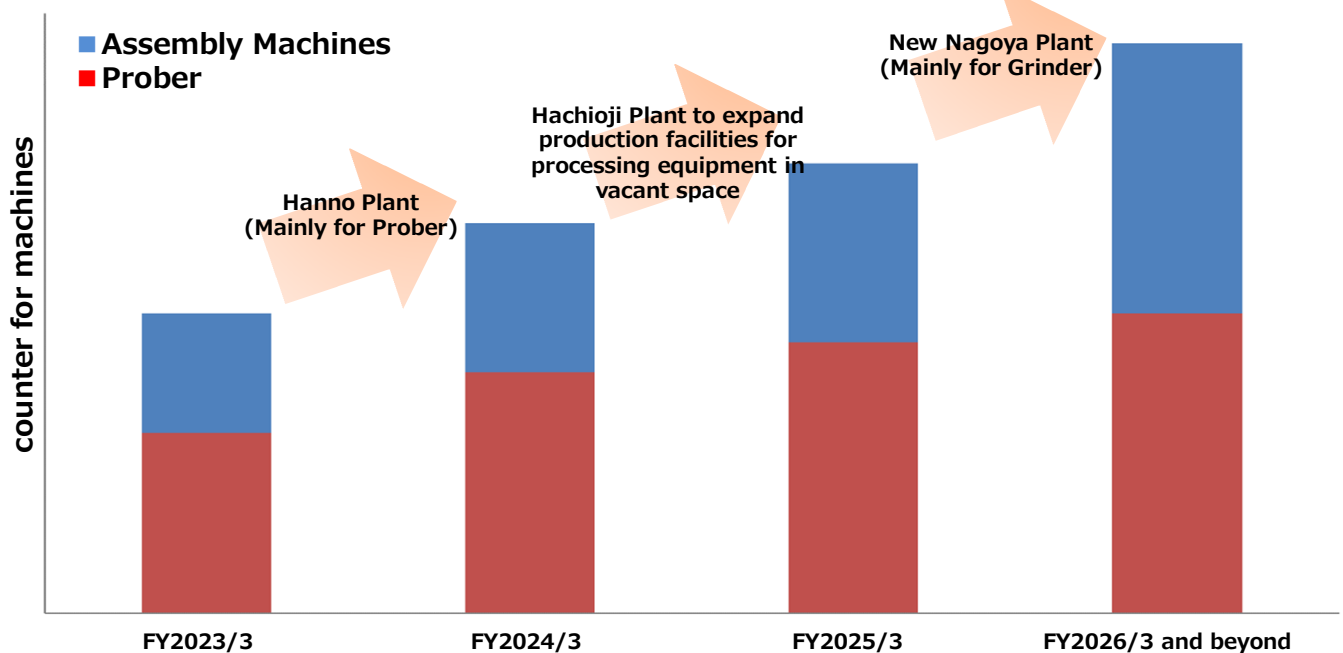
Element	Company's Business Opportunities and Strengths
SiC	<ul style="list-style-type: none"> ● Equipment demand is shifting from substrate processing to device processing ● High Rigid Grinder(HRG), Edge Grinder ● Dicing blades for SiC, Prober
HBM	<ul style="list-style-type: none"> ● High precision wafer testing by Prober with customized chuck for HBM
AI Logic	<ul style="list-style-type: none"> ● High Rigid Grinder(HRG) ● Prober High-precision temperature control ● Dicer Edge-trimming, and Ablation dicing
Hybrid Bonding	<ul style="list-style-type: none"> ● High Rigid Grinder(HRG), CMP ● Enable to provide cleaning function as well as Front-end process
Demand due to geopolitical changes	<ul style="list-style-type: none"> ● Response to China Chiplet Strategy ● Wide range of product lineup (wafer fabrication to back-end process) ● Global Service and support
NEV Battery	<ul style="list-style-type: none"> ● X-ray CT technology (internal defects, object detection, electrode gap measurement) ● Charge / Discharge Testing System
Synergies from the fusion of SPE and Metrology	<ul style="list-style-type: none"> ● SPE "Metrology built-in" model ● High-precision non-contact measuring instruments ● Sales and service network for semiconductor business

- ◆ First, the majority of equipment demand for SiC processing will shift from substrate processing to device processing, which requires more grinding, This is expected to increase business opportunities for our various Grinders, Probers, and Dicers.
- ◆ For HBM, our Probers, which responding to "ALL NEEDS", responds to technical specifications such as high/low temperature chucks.
- ◆ For AI Logic, Grinders, Probers, and Dicers are our opportunities. Also, Ablation laser dicers can also be utilized.
- ◆ For Hybrid bonding, we respond with a HRG that can handle the required grinding precision and our well-established cleaning technology.
- ◆ In response to demand from China and geopolitical changes such as "China plus one" we respond with a broad product lineup and a global service/support system.
- ◆ For NEV batteries, X-ray CT technology to inspect the inside and charge/discharge test systems continue to be a major business opportunity.
- ◆ Regarding synergies from the integration of SPE and Metrology businesses, we integrate equipment with both technologies and promote sales to the semiconductor industries by utilizing the SPE sales network.

Capacity expansion



- An increase in Grinder demand is likely, based on a technology growth in new substrate materials packaging technology; the Company continues capacity expansion to respond



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- ◆ Finally, I would like to explain future trends in production capacity.
- ◆ To meet increasing demand for SPEs, we continue to expand our production capacity through plant construction.
- ◆ In this July, the *Hanno* Plant, mainly for Probers, began operations.
- ◆ Currently, we are expanding our Assembly machines' capacity in the space in the *Hachioji* Plant vacated by the transfer to the *Hanno* Plant.
- ◆ Through aforementioned activities, We believe we reach targeted capacity that are necessary to obtain MTP target.
- ◆ In addition, we are planning to build a plant in Nagoya, mainly for Grinders, in anticipation of increasing demands toward new compound semiconductors such as SiC and packaging technology.
- ◆ We continue to secure production capacity timely manner in anticipation of increased demand for semiconductors.
- ◆ That's all from myself. Thank you very much for your attention.

Agenda

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- ◆ **Q&A**



Investor Information:



<https://ir.accretech.jp/en/index.html>

Sustainability Information:



<https://www.accretech.jp/english/sustainability/index.html>

補足資料

Supplementary Data

Sustainability Report
Sep. 25th published.



Integrated Report
Oct. 30th JP ver. published.
Nov. End EN ver. will be publish



Japanese ver

セグメント別業績推移 Segment Information



(百万円) Million Yen	会計期間 Fiscal Year				四半期 Quarter								
	2020年 3月期 FY2020/3	2021年 3月期 FY2021/3	2022年 3月期 FY2022/3	2023年 3月期 FY2023/3	2023年3月期 FY2023/3				2024年3月期 FY2024/3				
					1Q	2Q	3Q	4Q	1Q	2Q	3Q	4Q	
受注高 Orders	半導体 SPE	57,709	93,181	152,896	99,366	35,918	25,246	20,663	17,537	20,345	21,957		
	計測 Metr.	29,866	23,878	33,159	36,960	10,246	8,788	9,472	8,452	9,225	7,981		
	合計 Total	87,576	117,060	186,056	136,326	46,165	34,034	30,136	25,990	29,571	29,938		
受注残高 Backlog	半導体 SPE	29,182	50,619	102,370	89,371	117,153	108,134	104,714	89,371	90,993	84,710		
	計測 Metr.	7,782	6,301	9,904	12,428	13,367	13,263	14,782	12,428	13,758	13,061		
	合計 Total	36,965	56,920	112,274	101,799	130,520	121,398	119,496	101,799	104,752	97,771		
売上高 Sales	半導体 SPE	56,198	71,745	101,145	112,365	21,135	34,264	24,084	32,880	18,722	28,241		
	計測 Metr.	31,728	25,359	29,556	34,436	6,783	8,892	7,954	10,806	7,895	8,678		
	合計 Total	87,927	97,105	130,702	146,801	27,919	43,156	32,038	43,687	26,618	36,919		
営業利益 Op Margin	半導体 SPE	7,915	13,565	24,698	29,866	5,049	8,874	6,416	9,526	3,208	5,773		
	計測 Metr.	4,366	1,996	3,628	4,628	641	1,120	1,031	1,834	1,042	1,365		
	合計 Total	12,282	15,562	28,327	34,494	5,691	9,994	7,448	11,361	4,250	7,138		
営業利益率 Op Margin	半導体 SPE	14.1%	18.9%	24.4%	26.6%	23.9%	25.9%	26.6%	29.0%	17.1%	20.4%		
	計測 Metr.	13.8%	7.9%	12.3%	13.4%	9.5%	12.6%	13.0%	17.0%	13.2%	15.7%		
	合計 Total	14.0%	16.0%	21.7%	23.5%	20.4%	23.2%	23.2%	26.0%	16.0%	19.3%		

損益計算書 Statements of Income



(百万円) Million Yen	会計期間 Fiscal Year				四半期 Quarter							
	2020年 3月期 FY2020/3	2021年 3月期 FY2021/3	2022年 3月期 FY2022/3	2023年 3月期 FY2023/3	2023年3月期 FY2023/3				2024年3月期 FY2024/3			
					1Q	2Q	3Q	4Q	1Q	2Q	3Q	4Q
売上高 Net Sales	87,927	97,105	130,702	146,801	27,919	43,156	32,038	43,687	26,618	36,919		
売上原価 Cost of goods sold	53,452	60,190	77,694	84,967	15,940	25,783	18,220	25,022	15,415	22,387		
売上総利益 Gross Profit on Sales	34,474	36,914	53,008	61,834	11,978	17,372	13,817	18,664	11,203	14,531		
販売費および一般管理費 Selling, general and administrative expenses	22,192	21,351	24,681	27,339	6,287	7,378	6,369	7,303	6,952	7,392		
営業利益 Operating profit	12,282	15,562	28,327	34,494	5,691	9,994	7,448	11,361	4,250	7,138		
営業外収益 Non-operating income	255	540	987	965	824	96	-229	274	563	245		
営業外費用 Non-operating expenses	177	235	153	162	18	25	111	7	103	22		
経常利益 Recurring Profit	12,360	15,867	29,160	35,297	6,496	10,065	7,107	11,628	4,710	7,361		
特別利益 Extraordinary gains	57	1,354	390	103	5	58	12	25	26	-		
特別損失 Extraordinary losses	1,712	1,074	34	2,099	-	-	1,751	347	-	14		
税引前利益 Profit before income taxes and minority interests	10,705	16,147	29,516	33,301	6,502	10,124	5,368	11,306	4,736	7,347		
法人税等合計 Total Income tax and others	3,598	3,978	8,132	9,607	1,660	3,019	2,011	2,916	1,456	1,998		
親会社株主に帰属する当期純利益 Net Profit attributable to Owners of the Parent	7,156	12,175	21,326	23,630	4,812	7,096	3,338	8,383	3,245	5,302		
1株当たり当期純利益(円) Net Profit per Share (Yen)	171.89	293.83	522.52	581.33	118.38	174.47	82.05	206.60	80.63	131.49		
潜在株式調整後 1株当たり当期純利益(円) Net Profit per Share (diluted) (Yen)	170.72	291.43	517.51	575.62	-	-	-	-	-	-		

Nov 2nd, 2023

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貸借対照表 Balance Sheet



(百万円) (Million Yen)		2021年3月期 FY2021/3	2022年3月期 FY2022/3	2023年3月期 FY2023/3	2024年3月期(2Q末) FY2024/3 (2Q)
流動資産 Current Assets	現金及び預金 Cash and cash equivalents	43,657	49,033	40,080	28,154
	売上債権※1 Accounts Receivable※1	30,946	38,367	43,403	40,442
	在庫 Inventories	32,886	40,325	53,482	63,029
	その他 Others	4,025	6,103	7,005	3,943
	合計 Total	111,516	133,829	143,972	135,570
	固定資産合計 Total Fixed Assets	50,039	56,457	65,060	69,954
	総資産 Total Assets	161,556	190,287	209,032	205,524
流動負債 Current Liabilities	買入債務※2 Accounts Payable※2	23,062	29,876	22,359	18,867
	その他 Others	16,233	25,765	28,588	24,968
	合計 Total	39,296	55,641	50,947	43,836
	固定負債合計 Total long-term liabilities	5,482	3,564	12,057	11,155
	負債合計 Total Liabilities	44,778	59,206	63,004	54,991
	純資産合計 Total Net Assets	116,777	131,081	146,028	150,533
	負債・純資産合計 Total Liabilities and Net Assets	161,556	190,287	209,032	205,524
	有利子負債合計 Total interest-bearing debt	7,581	5,497	14,191	12,140
	自己資本比率 Equity Ratio(%)	71.4%	68.1%	69.0%	72.3%
	自己資本利益率 ROE(%)	10.9%	17.4%	17.3%	-

※1: 電子記録債権、契約資産を含む

Incl. Electronically recorded monetary claims

※2: 電子記録債務を含む

Incl. Electronically recorded obligations-operating

各種費用, キャッシュフロー Expenses and Cash Flows



(百万円) (Million Yen)	2021年3月期 FY2021/3	2022年3月期 FY2022/3	2023年3月期 FY2023/3	2024年3月期(2Q) FY2024/3(2Q)
試験研究費 R&D expenses	7,193	8,146	8,542	4,554
設備投資 Capex	5,950	9,793	9,725	6,764
減価償却費 (のれん除く) Depreciation (excl. Amortization)	3,516	3,551	3,832	2,100

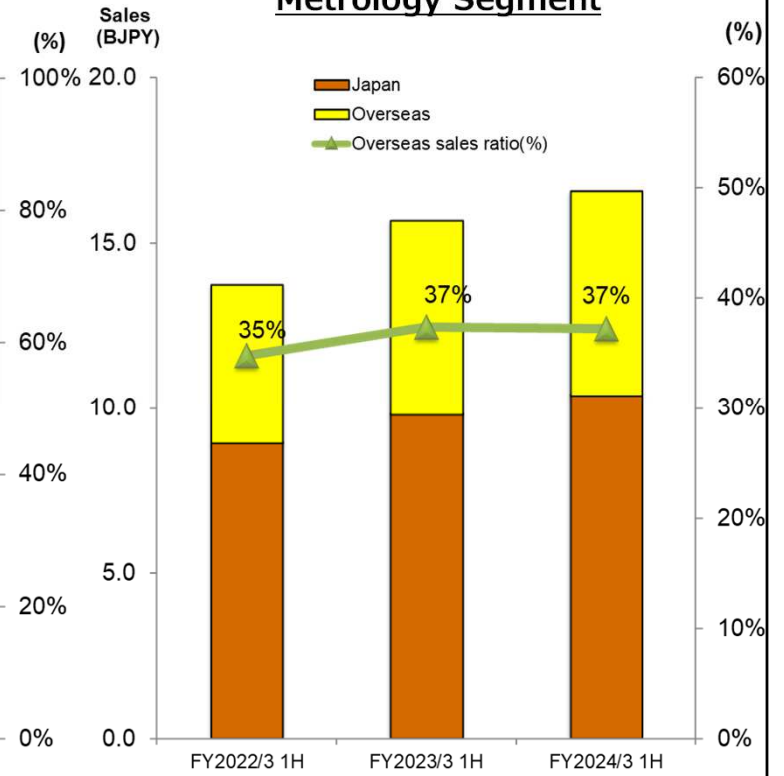
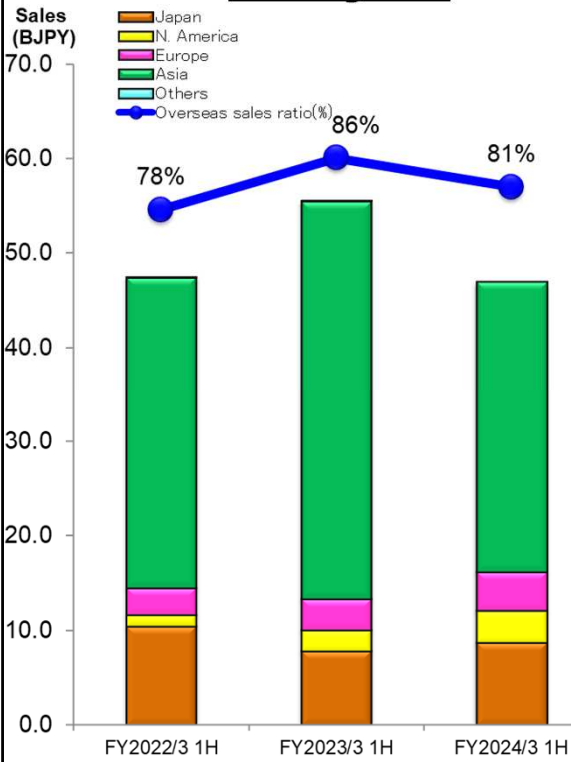
(百万円) (Million Yen)	2021年3月期 FY2021/3	2022年3月期 FY2022/3	2023年3月期 FY2023/3	2024年3月期(2Q) FY2024/3(2Q)
営業活動によるキャッシュフロー Cash flows from operating activities	22,062	23,837	1,000	1,832
投資活動によるキャッシュフロー Cash flows from investing activities	-5,191	-8,990	-8,421	-6,498
フリーキャッシュフロー Free cash flows	16,871	14,846	-7,421	-4,665
財務活動によるキャッシュフロー Cash flows from financing activities	-8,282	-10,346	-2,174	-7,821
現金及び現金同等物に係る換算差額等 Adjustments	429	882	625	559
現金及び現金同等物の期末残高 Cash and cash equivalents at the end of year	43,624	49,006	40,036	28,108

Sales per Region



SPE Segment

Metrology Segment

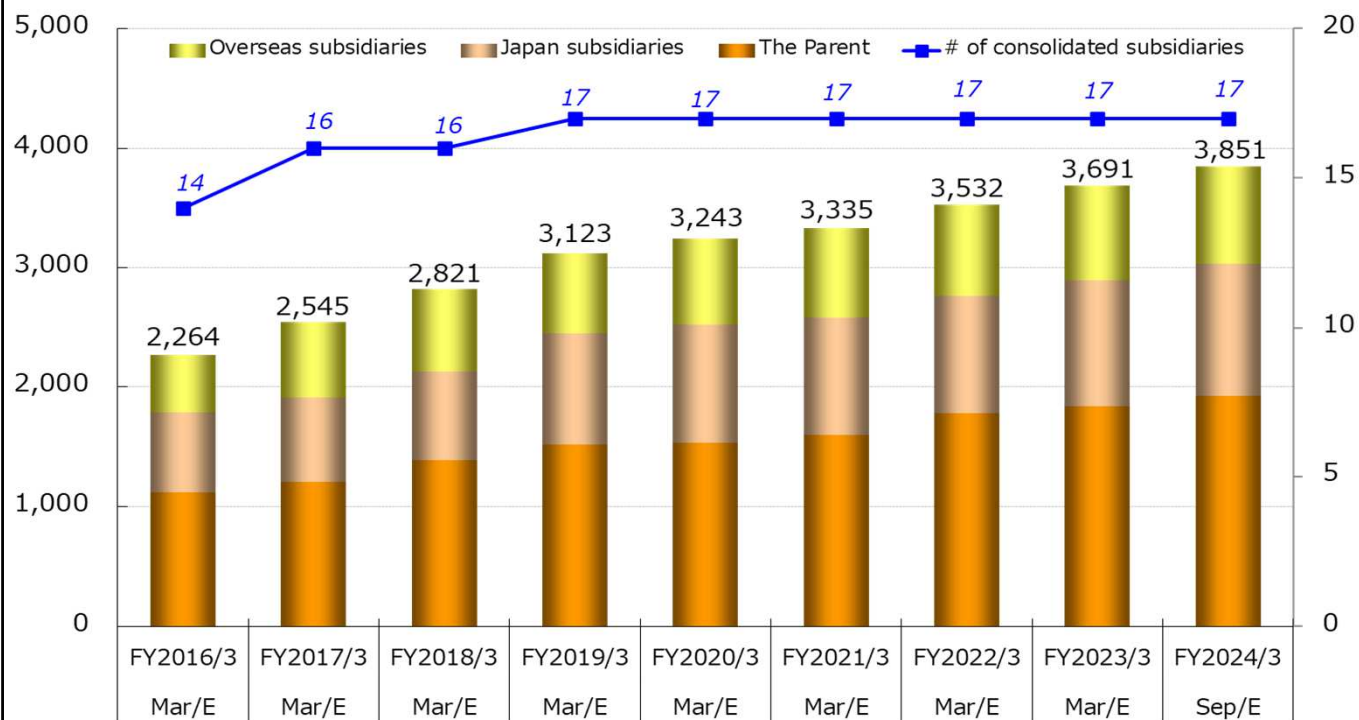


Number of employees



Number of Employees (person)

of Consolidated Subsidiaries



Note) Above figures include part time employees as at the end of each term